

11/L [2345/1866]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s)

Hartwig RICHTER et al.

Serial No.

09/529,700

Filed

April 18, 2000

Title

SEMICONDUCTOR LASER CHIP

Art Unit

2828

Examiner

James Davie

Commissioner for Patents Washington, D.C. 20231

Thereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231 on

Date: March 13, 20

Signature: Juda 7 1- Shud

AMENDMENT

Sir:

In response to the Office Action mailed on September 13, 2002, please reconsider the above-identified application based on the following:

IN THE CLAIMS:

Please cancel without prejudice claims 17 and 18.

Please amend without prejudice claims 16, 21, 26 and 32 as follows:

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16. (Twice amended) A semiconductor laser comprising:

a semiconductor laser chip; and

at least one temperature sensor configured to be integrated in the semiconductor laser chip for measuring an operating temperature,

wherein the at least one temperature sensor is secured by welding directly in the semiconductor laser chip, an energy for the welding coming from a light source, the light source including at least one of a ND-glass source, a Nd-YAG source and a source having a similar spatial distribution and similar spectral distribution to a Nd-glass source or a Nd-YAG 803/31/2003 TBELL1 80000008 110600 09529708 source.

OI FU: 1202

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